CLAIMS

We claim:

- 1 1. A bipolar transistor, comprising:
- a base;
- a base contact formed within the base; and
- an emitter contact formed within the base, wherein the
- 5 emitter contact surrounds the base contact.
- 1 2. The bipolar transistor of claim 1, further comprising a
- 2 collector contact formed within a subcollector.
- 1 3. The bipolar transistor of claim 1, wherein the emitter contact
- 2 forms a ring around the base contact.
- 1 4. The bipolar transistor of claim 1, wherein the base contact is
- 2 a point contact.
- 1 5. The bipolar transistor of claim 1, wherein wires of the base
- 2 contact and wires of the emitter contact are vertically stacked
- 3 atop the contacts.
- 1 6. The bipolar transistor of claim 5, wherein the wires of the
- 2 base contact are stacked at a level higher than the wires of the

- 3 emitter contact.
- 7. The bipolar transistor of claim 2, wherein wires of the
- 2 collector contact are stacked higher than wires of the emitter
- 3 contact.

- 8. A device, comprising:
- 2 a base;
- a base contact formed within the base; and
- an emitter contact formed within the base, wherein the
- 5 emitter contact extends around at least two sides of the base
- 6 contact.
- 9. The device of claim 8, wherein the emitter contact surrounds
- 2 the base contact.
- 1 10. The device of claim 8, wherein the emitter contact forms a
- 2 ring around the base contact.
- 1 11. The device of claim 8, wherein the base contact is a point
- 2 contact.
- 1 12. The device of claim 8, further comprising a collector contact
- 2 formed within a subcollector.
- 1 13. The device of claim 8, wherein wires of the base contact and
- 2 wires of the emitter contact are vertically stacked atop the
- 3 contacts.

- 1 14. The device of claim 13, wherein the wires of the base contact
- 2 are stacked at a level higher than the wires of the emitter
- 3 contact.
- 1 15. The device of claim 12, wherein wires of the collector
- 2 contact are stacked higher than wires of the emitter contact.

- 1 16. A bipolar transistor, comprising:
- a base;
- 3 an emitter contact formed within the base;
- a base contact formed within the base; and
- a first wiring stack formed atop the emitter contact and a
- 6 second wiring stack formed atop the base contact, wherein the
- 7 second wiring stack includes at least one more wiring level than
- 8 the first wiring stack.
- 1 17. The bipolar transistor of claim 16, further comprising a
- 2 collector contact formed within a subcollector.
- 1 18. The bipolar transistor of claim 16, wherein the emitter
- 2 contact surrounds the base contact on at least two sides.
- 1 19. The bipolar transistor of claim 16, wherein the emitter
- 2 contact forms a ring around the base contact.
- 1 20. The bipolar transistor of claim 16, wherein the base contact

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2 is a point contact.

- 1 21. A device, comprising:
 - 2 at least two bipolar transistors, wherein each bipolar
 - 3 transistor further comprises:
 - a base contact;
 - an emitter contact surrounding the base contact; and
 - 6 wherein at least one side of the emitter contact of the at
 - 7 least two bipolar transistors are in electrical contact.
 - 1 22. The device of claim 21, wherein the emitter contact forms a
 - 2 ring around the base contact.
 - 1 23. The device of claim 21, wherein the base contact is a point
 - 2 contact.
 - 1 24. The device of claim 21, wherein wires of the base contact and
 - 2 wires of the emitter contact are vertically stacked atop the
 - 3 contacts.
 - 1 25. The device of claim 24, wherein the wires of the base contact
 - 2 are stacked at a level higher than the wires of the emitter
 - 3 contact.

- 1 26. The device of claim 21, further including a collector
- 2 contact.
- 1 27. The device of claim 26, wherein wires of the collector
- 2 contact are stacked higher than wires of the emitter contact.
- 1 28. The device of claim 21, wherein at least one side of each
- 2 emitter contact of the electrically connected transistors is in
- 3 physical contact.

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- 1 29. A device, comprising:
- 2 at least two bipolar transistors, wherein the bipolar
- 3 transistors are electrically connected to one another, wherein a
- 4 first bipolar transistor has a first wiring stack and a second
- 5 bipolar transistor has a second wiring stack, and wherein the
- 6 second wiring stack comprises at least one more wiring level than
- 7 the first wiring stack.
- 1 30. The device of claim 29, wherein the bipolar transistors
- comprise:
- a base contact; and
- an emitter contact surrounding the base contact.
- 1 31. The device of claim 29, wherein current is supplied to the
- 2 first bipolar transistor.